

Title (en)

Device for separating cut-board portions for application to a trimming machine

Title (de)

Plattenabschnitttrennvorrichtung zur Anwendung in einer Abbundanlage

Title (fr)

Installation de séparation de portions de panneaux coupés destinée à être appliquée dans un machine de taillage

Publication

**EP 1275479 A1 20030115 (EN)**

Application

**EP 02008824 A 20020419**

Priority

IT MI20011475 A 20010710

Abstract (en)

A device (1) for separating cut-board portions, designed for application to a trimming machine (40), is characterized in that said device (1) comprises a motor-driven roller assembly (3) which can be raised and lowered with respect to a surface defined by two or more pluralities of conveyor chains (5,6,9) which are arranged in perpendicular directions to the roller assembly (3) feeding direction and can slide in opposite directions. <IMAGE>

IPC 1-7

**B27B 31/08**; B65G 47/53

IPC 8 full level

**B27B 31/00** (2006.01); **B27B 31/08** (2006.01)

CPC (source: EP)

**B27B 31/003** (2013.01); **B27B 31/006** (2013.01); **B27B 31/08** (2013.01)

Citation (search report)

- [A] PATENT ABSTRACTS OF JAPAN vol. 015, no. 491 (M - 1190) 12 December 1991 (1991-12-12)
- [A] PATENT ABSTRACTS OF JAPAN vol. 016, no. 094 (M - 1219) 9 March 1992 (1992-03-09)

Cited by

CN112298978A

Designated contracting state (EPC)

AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE TR

DOCDB simple family (publication)

**EP 1275479 A1 20030115**; **EP 1275479 B1 20040721**; AT E271449 T1 20040815; DE 60200773 D1 20040826; IT MI20011475 A0 20010710; IT MI20011475 A1 20030110

DOCDB simple family (application)

**EP 02008824 A 20020419**; AT 02008824 T 20020419; DE 60200773 T 20020419; IT MI20011475 A 20010710